

Surface Mount Schottky Power Rectifier

SMB Power Surface Mount Package

SS22T3G, SS24T3G, NRVBSS24T3G, **NRVBSS24NT3G**

These devices employ the Schottky Barrier principle in a metal-to-silicon power rectifier. Features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency switching power supplies; free wheeling diodes and polarity protection diodes.

Features

- Compact Package with J-Bend Leads Ideal for Automated Handling
- Highly Stable Oxide Passivated Junction
- Guardring for Over-Voltage Protection
- Low Forward Voltage Drop
- NRVB Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable*
- These Devices are Pb-Free and are RoHS Compliant

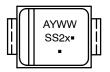
Mechanical Characteristics

- Case: Molded Epoxy
- Epoxy Meets UL 94 V-0 @ 0.125 in
- Weight: 95 mg (approximately)
- Cathode Polarity Band
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Available in 12 mm Tape, 2500 Units per 13 in Reel, Add "T3" Suffix to Part Number
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- ESD Ratings: Machine Model = C Human Body Model = 3B

SCHOTTKY BARRIER RECTIFIER 2 AMPERES 20, 40 VOLTS



MARKING DIAGRAM



SS2x = Specific Device Code

= 2 ro 4Х

Α = Assembly Location**

= Year WW = Work Week = Pb-Free Package

(Note: Microdot may be in either location)

**The Assembly Location code (A) is front side optional. In cases where the Assembly Location is stamped in the package, the front side assembly code may be blank.

ORDERING INFORMATION

Device	Package	Shipping [†]
SS24T3G	SMB (Pb-Free)	2500 / Tape & Reel
NRVBSS24NT3G*	SMB (Pb-Free)	2500 / Tape & Reel

DISCONTINUED (Note 1)

1

SS22T3G	SMB (Pb-Free)	2500 / Tape & Reel	
NRVBSS24T3G*	SMB (Pb-Free)	2500 / Tape & Reel	

- †For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
- 1. **DISCONTINUED:** These devices are not recommended for new design. Please contact your onsemi representative for information. The most current information on these devices may be available on www.onsemi.com.

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MAXIMUM RATINGS

Symbol	Rating	Value	Unit
V _{RRM} V _{RWM}	Peak Repetitive Reverse Voltage Working Peak Reverse Voltage		V
V _R	DC Blocking Voltage SS22 SS24	20 40	
lo	Average Rectified Forward Current (At Rated V_R , $T_L = 132$ °C)	2.0	А
I _{FRM}	Peak Repetitive Forward Current (At Rated V_R , Square Wave, 100 kHz, $T_C = 127^{\circ}C$)	3.0	А
I _{FSM}	Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	75	А
T _{stg} , T _C	Storage/Operating Case Temperature	−55 to +150	°C
T_J	Operating Junction Temperature (Note 1)	-55 to +150	°C
dv/dt	Voltage Rate of Change (Rated V _R , T _J = 25°C)	10,000	V/μs

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Symbol	Characteristic	Value	Unit
	Thermal Resistance,		°C/W
$R_{ hetaJL}$	Junction-to-Lead (Note 2)	24	
	Thermal Resistance,		
$R_{ hetaJA}$	Junction-to-Ambient (Note 3)	80	

ELECTRICAL CHARACTERISTICS

Symbol	Characteristic	Value		Unit	
٧F	Maximum Instantaneous Forward Voltage (Note 4)		T _J = 25°C	T _J = 125°C	V
	see Figure 2	$(i_F = 2.0 A)$	0.50	0.46	
I _R	Maximum Instantaneous Reverse Current (Note 4)		T _J = 25°C	T _J = 100°C	mA
	see Figure 4	$(V_R = 40 V)$	0.4	5.7	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

- 2. Mounted with minimum recommended pad size, PC Board FR4.
- 3. 1 inch square pad size (1 x 0.5 inch for each lead) on FR4 board.
- 4. Pulse Test: Pulse Width \leq 250 $\mu s,$ Duty Cycle \leq 2.0%.

^{1.} The heat generated must be less than the thermal conductivity from Junction-to-Ambient: $dP_D/dT_J < 1/R_{\theta JA}$.

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TYPICAL CHARACTERISTICS

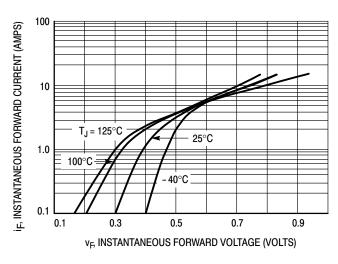


Figure 1. Typical Forward Voltage

Figure 2. Maximum Forward Voltage

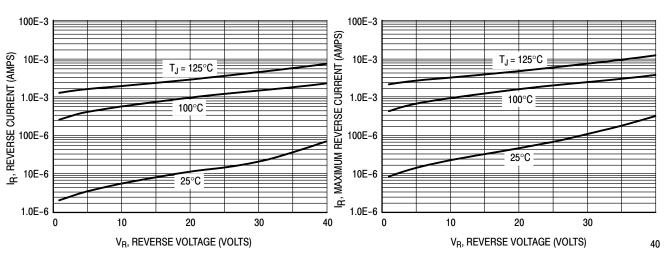
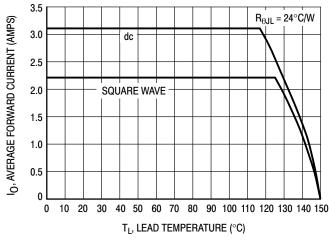


Figure 3. Typical Reverse Current

Figure 4. Maximum Reverse Current



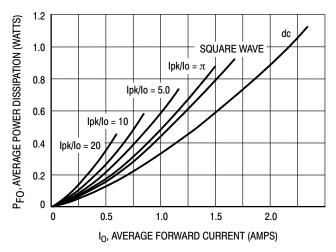
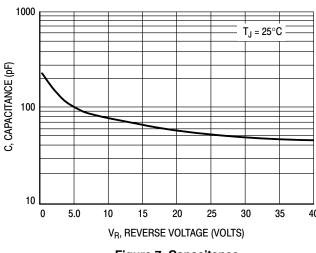


Figure 5. Current Derating

Figure 6. Forward Power Dissipation

2.5

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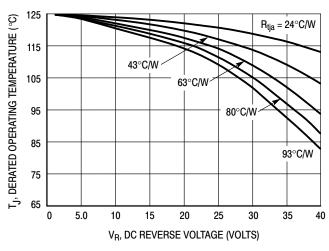


Figure 7. Capacitance

Figure 8. Typical Operating Temperature Derating*

* Reverse power dissipation and the possibility of thermal runaway must be considered when operating this device under any reverse voltage conditions. Calculations of T_J therefore must include forward and reverse power effects. The allowable operating T_J may be calculated from the equation: $T_J = T_{Jmax} - r(t)(Pf + Pr)$ where

 $r(t) = r_{\text{Jmax}} - r(t)(Pt + Pt)$ where r(t) = thermal impedance under given conditions,

T(t) = thermal impedance under given condition

Pf = forward power dissipation, and

Pr = reverse power dissipation

This graph displays the derated allowable T_J due to reverse bias under DC conditions only and is calculated as $T_J = T_{Jmax} - r(t)Pr$, where r(t) = Rthja. For other power applications further calculations must be performed.

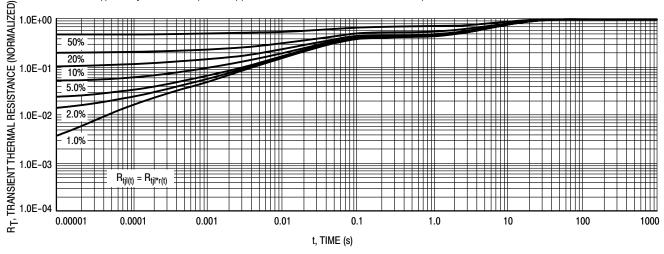


Figure 9. Thermal Response — Junction to Case

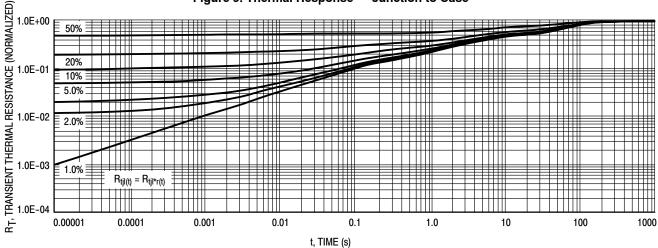


Figure 10. Thermal Response — Junction to Ambient





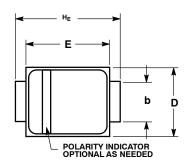


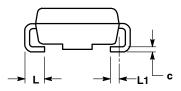
SMB CASE 403A-03 **ISSUE J**

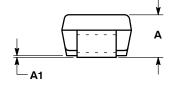
DATE 19 JUL 2012

Polarity Band

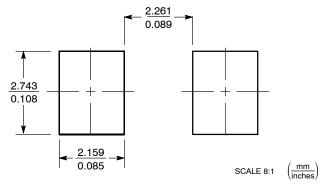
SCALE 1:1 Non-Polarity Band







SOLDERING FOOTPRINT*



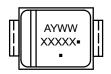
*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCL.
- CONTROLLING DIMENSION: INCH.
 DIMENSION b SHALL BE MEASURED WITHIN DIMENSION L1.

	MILLIMETERS				INCHES	
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	1.95	2.30	2.47	0.077	0.091	0.097
A1	0.05	0.10	0.20	0.002	0.004	0.008
b	1.96	2.03	2.20	0.077	0.080	0.087
С	0.15	0.23	0.31	0.006	0.009	0.012
D	3.30	3.56	3.95	0.130	0.140	0.156
E	4.06	4.32	4.60	0.160	0.170	0.181
HE	5.21	5.44	5.60	0.205	0.214	0.220
L	0.76	1.02	1.60	0.030	0.040	0.063
L1		0.51 REF			0.020 REF	

GENERIC MARKING DIAGRAM*





Polarity Band

Non-Polarity Band

XXXXX = Specific Device Code = Assembly Location

= Year WW = Work Week = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

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